

MU3D

SURFACE MOUNT ULTRAFAST RECTIFIER

VOLTAGE : 200V

CURRENT : 3.0A



FEATURE

Plastic package has Underwriters Laboratories Flammability Classification 94V-
Ideally suited for use in very high frequency switching power supplies, inverters and as free wheeling diodes
Ultrafast recovery time for high efficiency
High surge capability
High temperature soldering guaranteed
260 /10sec/at terminals
Glass passivated chip

MECHANICAL DATA

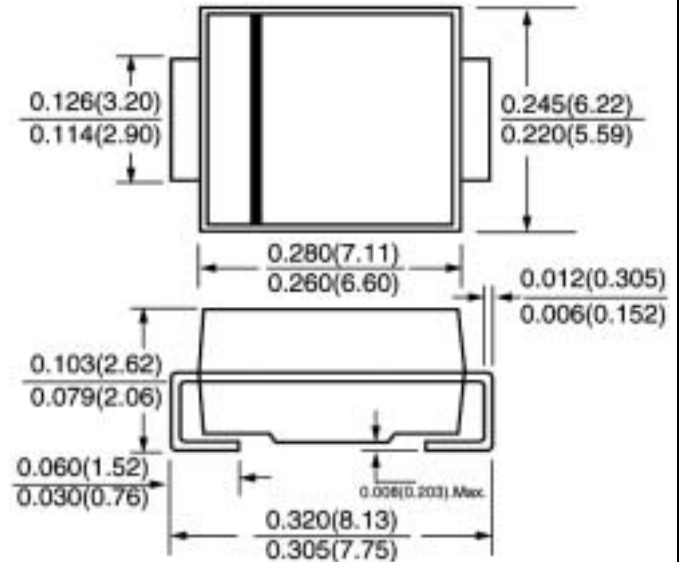
Terminals: Solder plated, solderable per MIL-STD-750, Method 2026

Case: JEDEC DO-214AB molded plastic body over passivated chip

Polarity: Color band denotes cathode end

Weight: 0.007 ounce, 0.21 gram

SMC / DO—214AB



Dimensions in inches and (millimeters)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

(single-phase, half-wave, 60HZ, resistive or inductive load rating at 25 °C, unless otherwise stated, for capacitive load, derate current by 20%)

	SYMBOL	MU3D	units
Maximum Recurrent Peak Reverse Voltage	V _{rrm}	200	V
Maximum RMS Voltage	V _{rms}	140	V
Maximum DC blocking Voltage	V _{dc}	200	V
Maximum Average Forward Rectified Current I _{f(av)} at T _L =140 °C Current 3/8 lead length at : T _L =130 °C	I _{f(av)}	3.0 4.0	A
Peak Forward Surge Current 8.3ms single half sine- wave superimposed on rated load	I _{fsm}	125.0	A
Maximum Instantaneous Forward Voltage at rated forward current T _J =25 °C I _f =3.0A	V _f	0.875	V
Maximum DC Reverse Current at rated DC blocking voltage T _a =25 °C T _a =150 °C	I _r	5.0 150.0	μA μA
Maximum Reverse Recovery Time (Note 1)	T _{rr}	25	nS
Typical Junction Capacitance (Note 2)	C _j	80	pF
Typical Thermal Resistance, junction to lead	R(jl)	11	/W
Storage and Operating Junction Temperature	T _{stg} , T _J	-50 to +175	

Note :

1. Reverse Recovery Condition I_f =0.5A, I_r =1.0A, I_{rr} =0.25A
2. Measured at 1.0 MHz and applied reverse voltage of 4.0Vdc

Fig. 1 – Forward Current Derating Curve

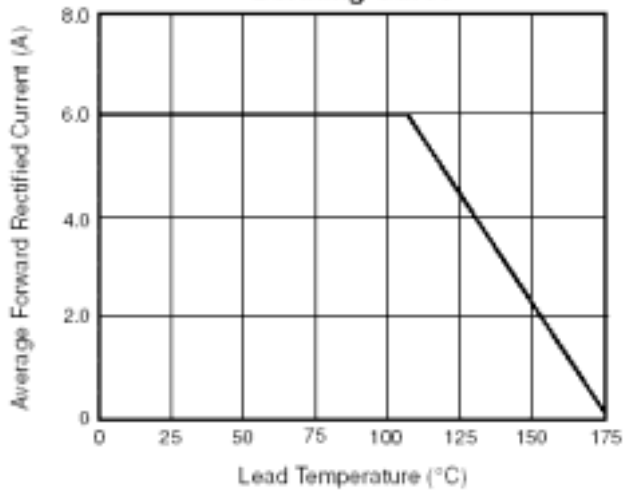


Fig. 2 – Maximum Non-Repetitive Peak Forward Surge Current

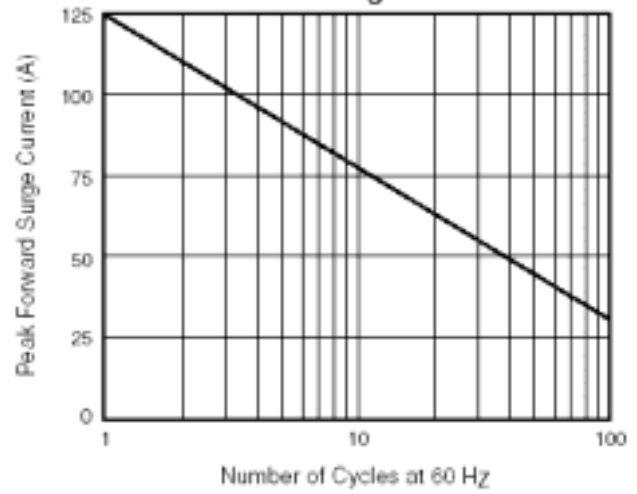


Fig. 3 – Typical Forward Voltage

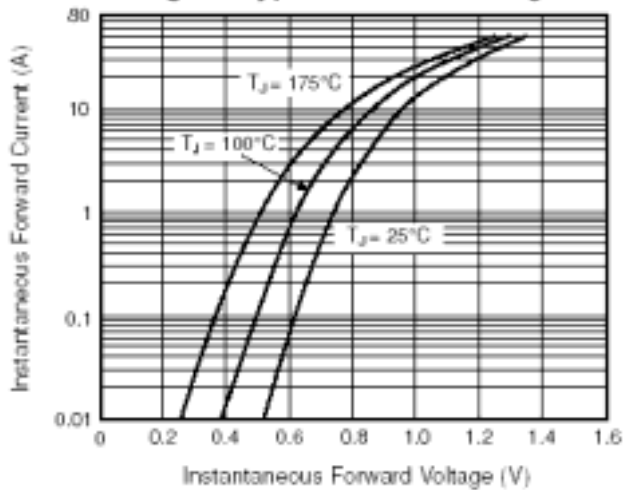


Fig. 4 – Typical Reverse Leakage Characteristics

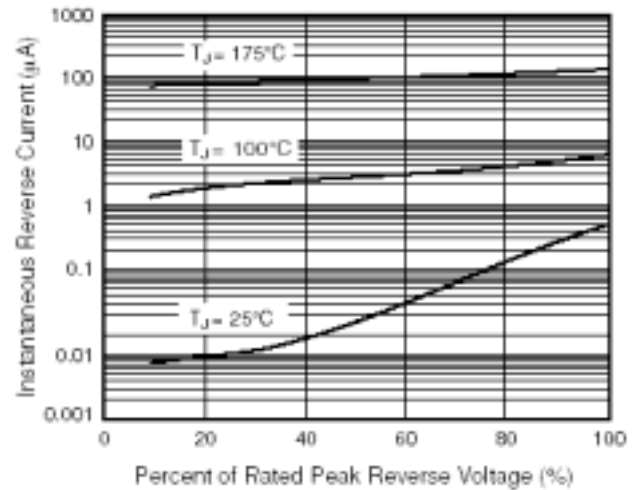


Fig. 5 – Typical Junction Capacitance

